REFLECTIONLESS FILTERS

 50Ω DC to 21 GHz

The Big Deal

- •High Stopband rejection, up to 50 dB
- Patented design terminates stopband signals
- •Pass band cut-off up to 11 GHz
- •Stop band up to 26 GHz
- Excellent repeatability through IPD* process



Product Overview

Mini-Circuits' *X-Series* of reflectionless filters now includes 2- and 3-section models, giving you ultra-high rejection in the stopband – up to 50 dB! Reflectionless filters employ a patented filter topology which absorbs and terminates stopband signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stopband, sending signals back to the source at 100% power. These reflections interact with neighboring components and often result in intermodulation and other interferences. By eliminating stopband reflections, reflectionless filters can readily be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages			
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals falling in filter stopband, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.			
High stopband rejection, up to 50 dB	Ideal for applications where suppression of strong spurious signals and intermodulation products is needed.			
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stopband; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.			
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect passband signals. Low & highpass filters can be cascaded to realize bandpass filters.			
Excellent power handling in a tiny surface mount device up to 7W in passband	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.			
Small size, 3x3mm/ 4x4 mm/ 5x5mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, saving board space.			
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.			
Excellent stability over temperature	With ± 0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.			
Operating temperature up to 105°C	Suitable for operation close to high power components.			

^{*}IPD - Integrated Passive Device, is a GaAs semiconductor process



Reflectionless Low Pass Filter

XLF-42M+

50 Ω DC to 300 MHz

Features

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent stopband rejection, 49 dB typ.
- Temperature stable, up to 105°C
- Small size, 5 x 5 mm
- Protected by US Patents 8,392,495; 9,705,467, additional patent pending
- Protected by China Patent 201080014266.1
- Protected by Taiwan Patent I581494

Applications

- Aircraft / Military communications
- FM radio
- · Earth exploration satellite
- · Radio astronomy
- · Mobile satellite



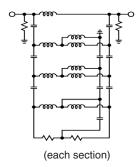
Generic photo used for illustration purposes of CASE STYLE: DG1677-2

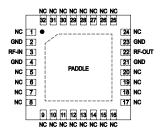
+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

General Description

Mini-Circuits' XLF-42M+ two-section reflectionless filter employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

simplified schematic and pad description





Function	Pad Number	Description	
RF-IN	3	RF Input Pad	
RF-OUT	22	RF Output Pad	
GND	2,4,21,23	Connected to ground	
NC (GND Externally)	1,5-20,24-32 & paddle	No internal connection	

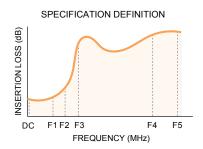
Electrical Specifications¹ at 25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Insertion Loss		DC - 300	_	2.3	3.1	dB
Pass Band	Frequency Cut-off	F2	350	_	3.0	_	dB
	VSWR	DC - F1	DC - 300	_	1.3	_	:1
		F3 - F4	660 - 6800	17	34	_	dB
	Rejection		6800 - 10000	41	49	_	dB
Stop Band							_
	VSWR	F3 - F4	660 - 6800	_	1.3	_	:1
	-	F4 - F5	6800 - 10000	_	2.2	_	:1

¹ Measured on Mini-Circuits Characterization Test Board TB-944-42M+

Absolute Maximum Ratings⁴

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (DC-F1) ²	5.0W at 25°C
RF Power Input, Stopband (F2-F5)3	1.6W at 25°C

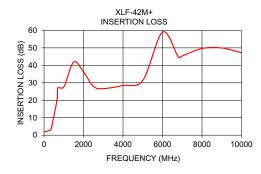


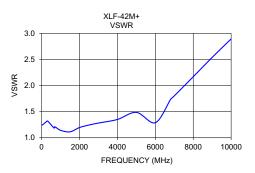
ESD rating

Human body model (HBM): Class 1B (pass 500V) in accordance with ANSI/ESD 5.1-2001

Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)		
10	2.00	1.24		
100	2.08	1.26		
300	2.79	1.32		
350	3.11	1.31		
660	20.36	1.19		
700	27.07	1.21		
1000	27.55	1.14		
1500	41.89	1.11		
2000	36.20	1.20		
2500	27.96	1.24		
3000	26.65	1.28		
4000	28.44	1.35		
5000	31.27	1.49		
6000	59.02	1.29		
6800	44.75	1.73		
7000	45.39	1.80		
8000	49.63	2.17		
9000	49.94	2.54		
10000	47.20	2.89		



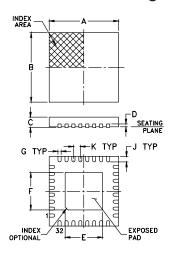


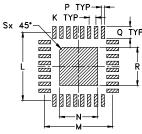


Passband rating derates linearly to 2.5W at 105°C ambient
 Stopband rating derates linearly to 0.8W at 105°C ambient
 Permanent damage may occur if any of these limits are exceeded.



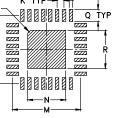
Outline Drawing





Tolerance to be within ±.002

PCB Land Pattern



Suggested Layout,

PACKAGE OUTLINE Ø.013 PTH FOR GROUND -PIN 1 RF IN RF OUT

COPLANAR WAVEGUIDE: .022 TRACE WIDTH & .014 GAP, 2 PL. (SEE NOTE BELOW)

Demo Board MCL P/N: TB-944-42M+

Suggested PCB Layout: PL-518

- 1. TRACE WIDTH & GAP ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .010" ± .001"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

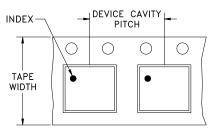
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Outline Dimensions (inch)

J	Н	G	F	Е	D	C MIN	C MAX	В	Α
.016	_'	.009	.142	.142	.008	.031	.039	.197	.197
0.41	-	0.23	3.61	3.61	0.20	0.79	0.99	5.00	5.00
wt		S	R	Q	Р	N	М	L	K
grams		0.008	.110	.035	.012	.110	.193	.193	.020
0.05		0.20	2 79	0.89	0.30	2 79	4.90	4.90	0.51

Tape & Reel Packaging, F68

DEVICE ORIENTATION IN T&R



DIRECTION OF FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note		
12	12 8	7	Small quantity standard	20 50 100 200 500	
			7	Standard	1000
			13	Standard	2000 3000 4000

Lead Finish: Matte-Tin

Product Marking

